

## 4: Surface Mateable High Density Metal Keyed Electrical Connectors



### HDM (Hydrobond Deck Mate)

#### FEATURES

- Robust, Compact, High Integrity Design
- Proven shock and vibration tested design
- High Pin Densities
- Positive Metal Key Way prevents misalignment and rotation
- Scoop proof design
- Barrel O – Ring seals for ease of maintenance and reliability
- Locking grub screws on coupling ring
- Depth rated to 3,450 MSW standard version. (6,900 MSW on request)
- Fully open face pressure sealed
- Available in 6 shell sizes
- Bulkhead Mount and Panel Mount Designs available as standard
- Mounting O – Ring face seals and optional Barrel seals available as standard
- Pin Densities from 3 to 73 ways
- Hard Gold Plated Contacts and Multi Leaved Sprung Sockets for positive connection
- Acetal dust caps included on all connectors (additional lanyards on request)
- Optional cost effective pressure sealing caps are available in a wide variety of materials
- Voltage ratings up to 3,300 Volts RMS
- Current ratings up to 95 Amps with higher ratings on request
- Standard and Reverse gender configurations available
- Available in 316 Stainless Steel as standard, Titanium, Aluminium Silicon Bronze, Nickel Aluminium Bronze etc on request
- Non Magnetic versions available
- 1 metre conductor tails on all bulkhead connectors as standard
- Optional Earth Bonding
- Termination options include fully water blocked, mechanical strain terminations and oil filled options
- Moulding options include Polyurethane and Polyethylene

#### BENEFITS

- Long life connector with easily maintained O – Ring seals.
- Designed for continual mate and de mate usage
- Easy to use pressure sealing caps
- Individual conductor Boot Seals allow mating in adverse conditions.
- Provides the best protection for your expensive electronics.
- Pins are protected during mating cycle
- Extremely cost effective
- Space saving high pin density designs require less space
- Wide variety of pin configurations allows cost effective system design
- Standard and reverse gender configurations allow for safe system design
- Wide variety of metal options allows for best corrosion resistant design

[www.hydrogroup.plc.uk](http://www.hydrogroup.plc.uk)

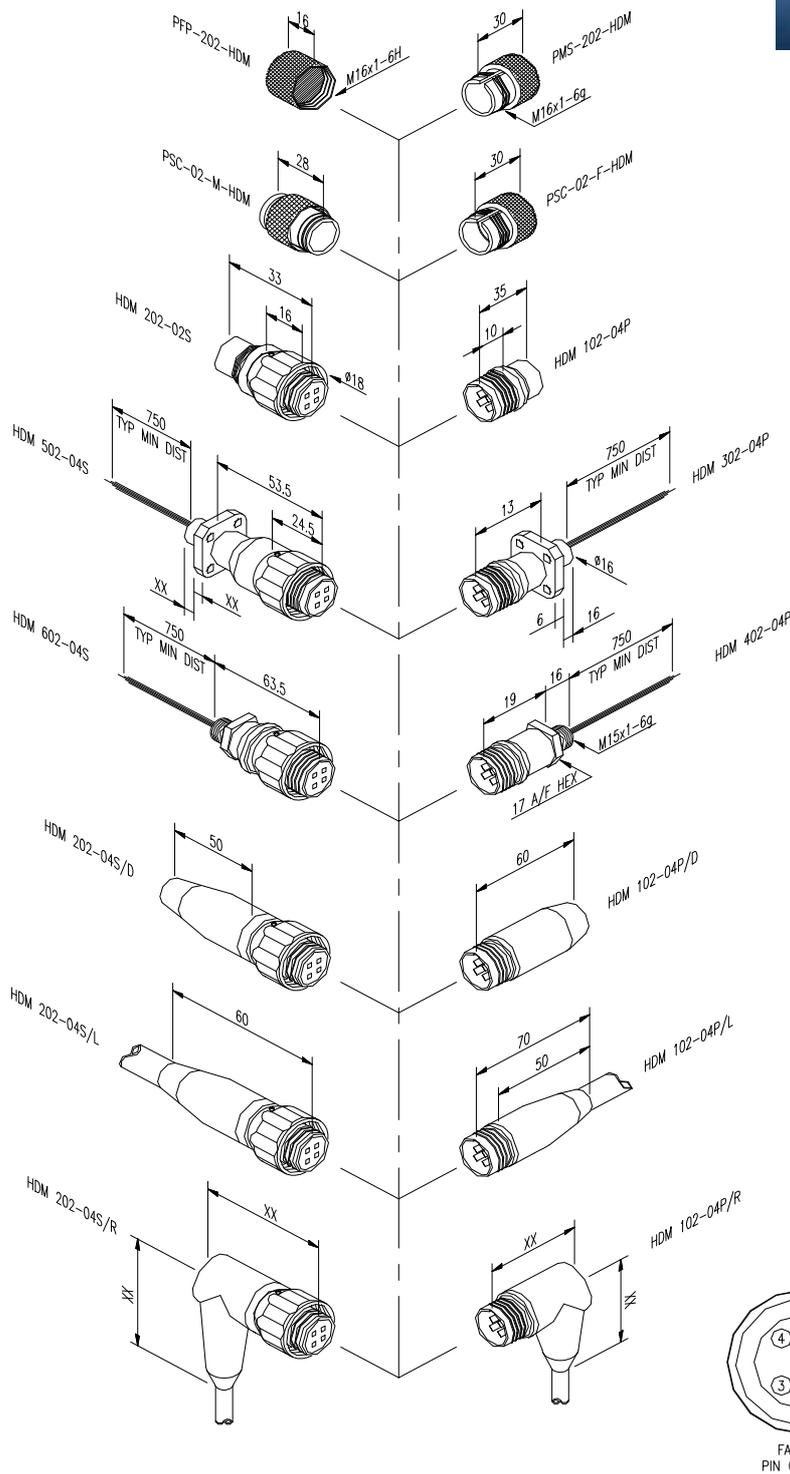
**Contact:** [sales@hydrogroup.plc.uk](mailto:sales@hydrogroup.plc.uk)

**Phone:** +44 (0)1224 822996

**Fax:** +44 (0)1224 825142



# HDM (Hydrobond Deck Mate) Surface Mateable Connector HDM\_02-04



**Electrical and Environmental:**

Pin Current Rating: 10 Amps  
 Pin Voltage Rating: 1,000 V rms  
 Contact to Contact IR: >1,000 MOhms @ 1,000 V dc  
 Contact to Body IR: >1,000 MOhms @ 1,000 V dc  
 Mated Depth Rating: 3,450 MSW  
 Temperature Rating: -20 ° C to +60 ° C  
 Conductor Tail Size: 16 AWG  
 Solder Bucket Size: 1.4 mm dia

**Standard Material Specification:**

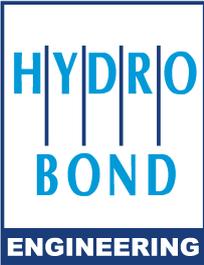
Body: 316 Stainless Steel  
 Fix Ring: Aluminium Silicon Bronze  
 Back Shell: N/A  
 Contact Pins: CZ121/Au  
 Contact Sockets: CZ121/Au  
 Insert Material: Peek  
 Conductor Tails: Spec 44 X 1.0 m.  
 O – Rings: NI70

**Data Sheet:**

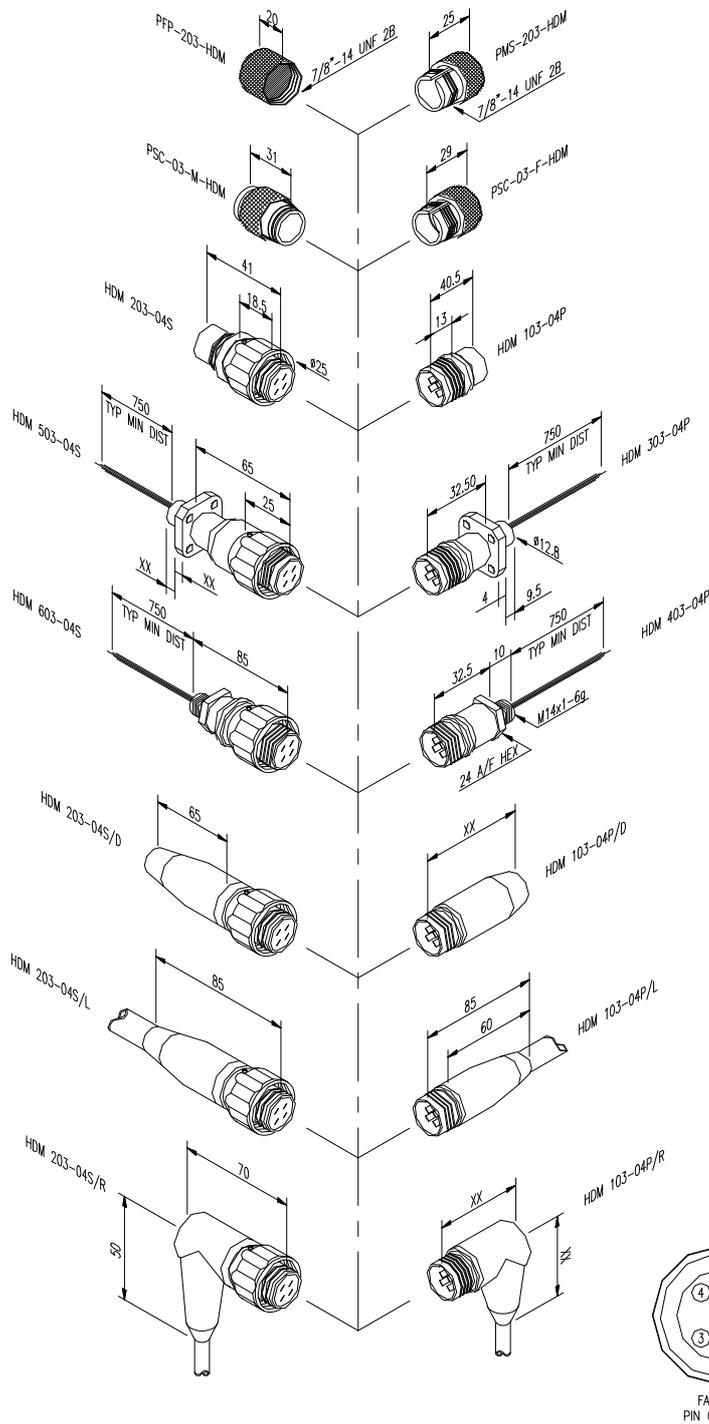
Issue: 03  
 Approved by:

**Mechanical:**

Lengths = mm  
 Threads = Metric  
**Mounting Detail:**  
 See Mounting Detail  
 Section of Binder



# HDM (Hydrobond Deck Mate) Surface Mateable Connector HDM\_03-04



### Electrical and Environmental:

Pin Current Rating: 10 Amps  
 Pin Voltage Rating: 1,000 V rms  
 Contact to Contact IR: >1,000 MOhms @ 1,000 V dc  
 Contact to Body IR: >1,000 MOhms @ 1,000 V dc  
 Mated Depth Rating: 3,450 MSW  
 Temperature Rating: -20 ° C to +60 ° C  
 Conductor Tail Size: 16 AWG  
 Solder Bucket Size: 1.4 mm dia

### Standard Material Specification:

Body: 316 Stainless Steel  
 Fix Ring: Aluminium Silicon Bronze  
 Back Shell: N/A  
 Contact Pins: CZI21/Au  
 Contact Sockets: CZI21/Au  
 Insert Material: Peek  
 Conductor Tails: Spec 44 X 1.0 m.  
 O – Rings: NI70

### Data Sheet:

Issue: 02  
 Approved by:

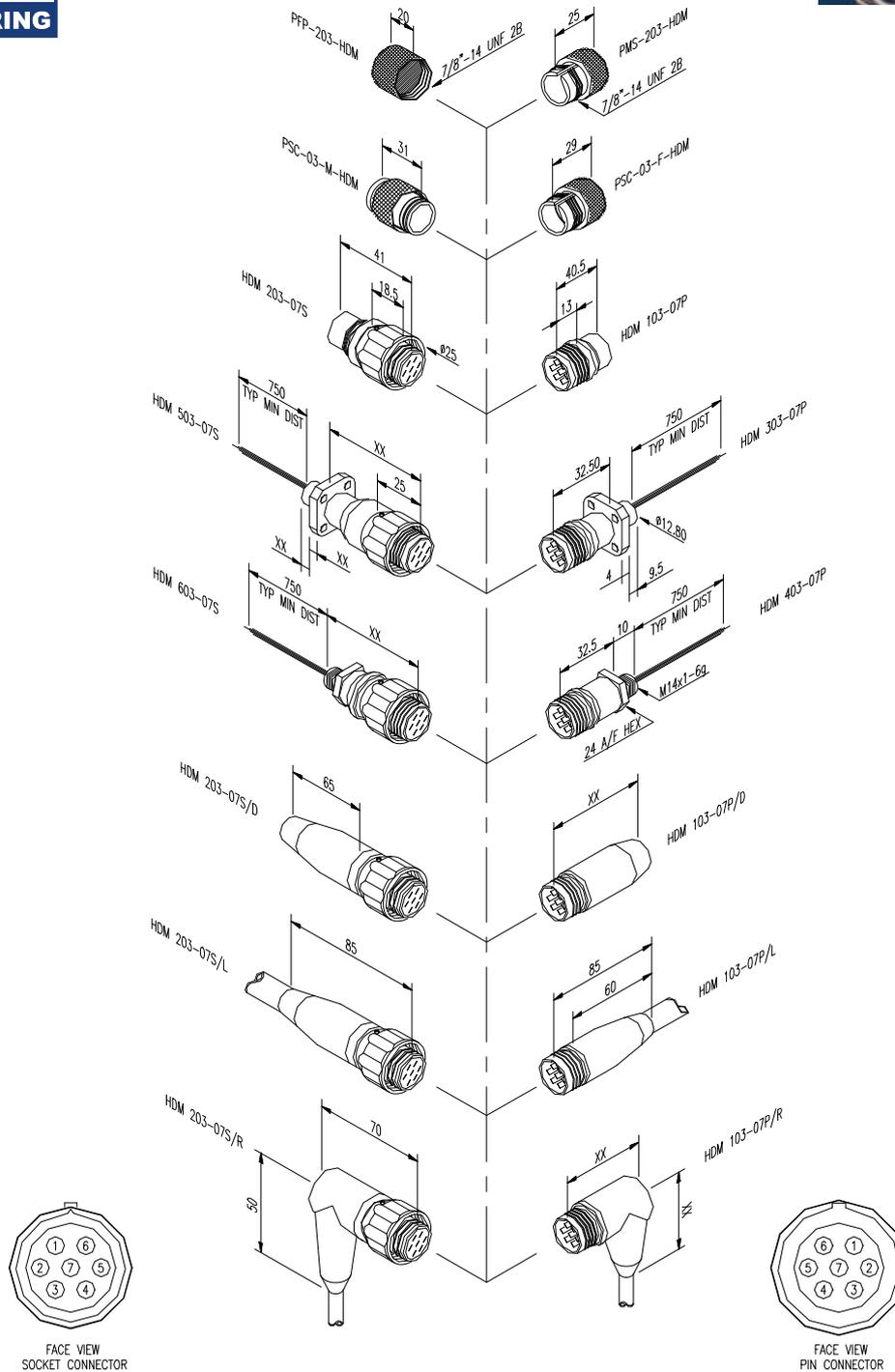
### Mechanical:

Lengths = mm  
 Threads = Metric  
 Mounting Detail:  
 See Mounting Detail  
 Section of Binder

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**HDM (Hydrobond Deck Mate)  
Surface Mateable Connector  
HDM\_03-07**



**Electrical and Environmental:**

Pin Current Rating: 5 Amps  
 Pin Voltage Rating: 1,000 V rms  
 Contact to Contact IR: >1,000 MOhms @ 1,000 V dc  
 Contact to Body IR: >1,000 MOhms @ 1,000 V dc  
 Mated Depth Rating: 3,450 MSW  
 Temperature Rating: -20 ° C to +60 ° C  
 Conductor Tail Size: 18 AWG  
 Solder Bucket Size: 1.5 mm dia

**Standard Material Specification:**

Body: 316 Stainless Steel  
 Fix Ring: Aluminium Silicon Bronze  
 Back Shell: N/A  
 Contact Pins: CZ121/Au  
 Contact Sockets: CZ121/Au  
 Insert Material: Peek  
 Conductor Tails: Spec 44 X 1.0 m.  
 O – Rings: NI70

**Data Sheet:**

Issue: 02  
 Approved by:

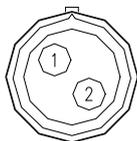
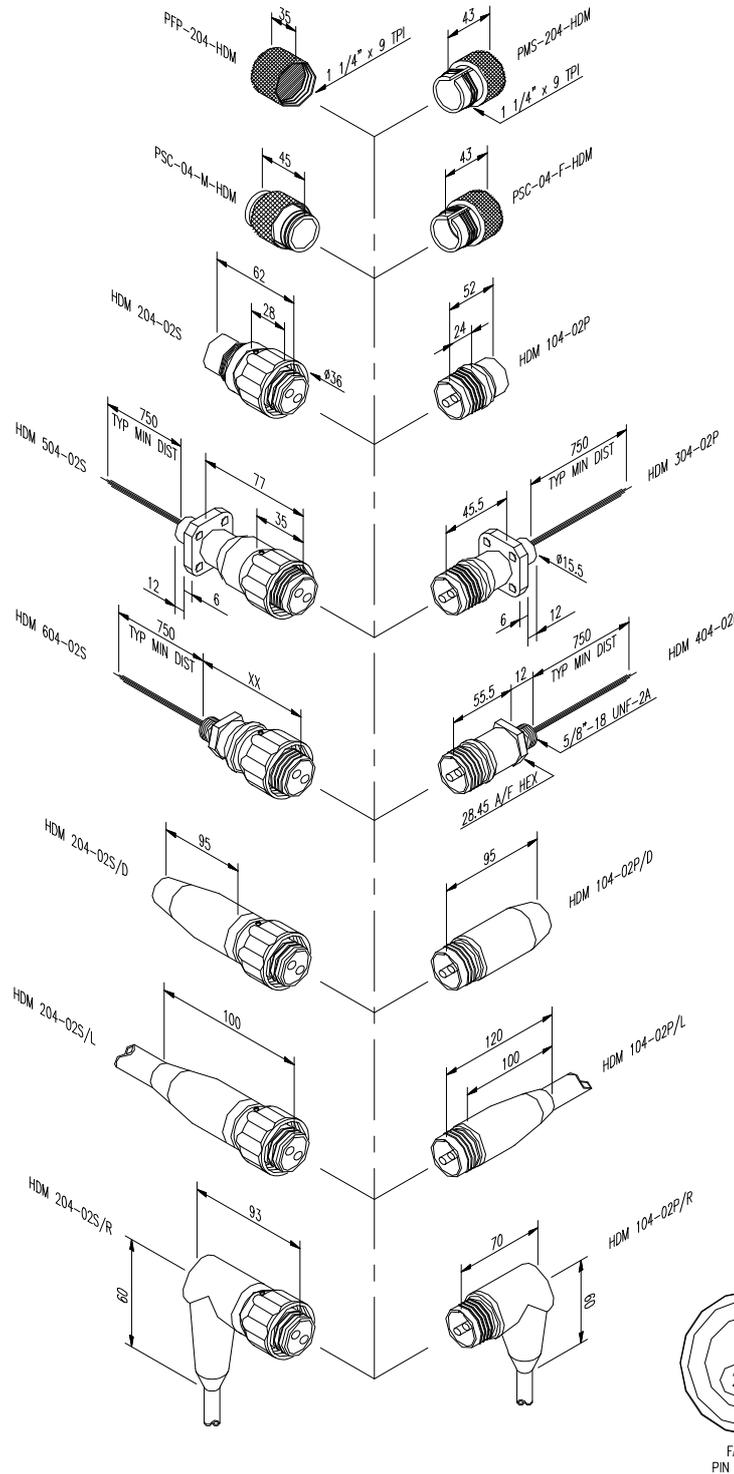
**Mechanical:**

Lengths = mm  
 Threads = Metric  
**Mounting Detail:**  
 See Mounting Detail  
 Section of Binder

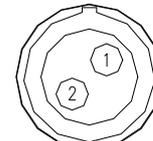
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**HDM (Hydrobond Deck Mate)  
Surface Mateable Connector  
HDM\_04-02**



FACE VIEW  
SOCKET CONNECTOR



FACE VIEW  
PIN CONNECTOR

**Electrical and Environmental:**

Pin Current Rating: 35 Amps  
 Pin Voltage Rating: 1,500 V rms  
 Contact to Contact IR: >1,000 MOhms @ 1,000 V dc  
 Contact to Body IR: >1,000 MOhms @ 1,000 V dc  
 Mated Depth Rating: 3,450 MSW  
 Temperature Rating: -20 ° C to +60 ° C  
 Conductor Tail Size: 9 AWG  
 Solder Bucket Size: 3.2 mm dia

**Standard Material Specification:**

Body: 316 Stainless Steel  
 Fix Ring: Aluminium Silicon Bronze  
 Back Shell: N/A  
 Contact Pins: CZI21/Au  
 Contact Sockets: CZI21/Au  
 Insert Material: Peek  
 Conductor Tails: Spec 44 X 1.0 m.  
 O – Rings: NI70

**Data Sheet:**

Issue: 02  
 Approved by:

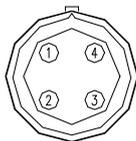
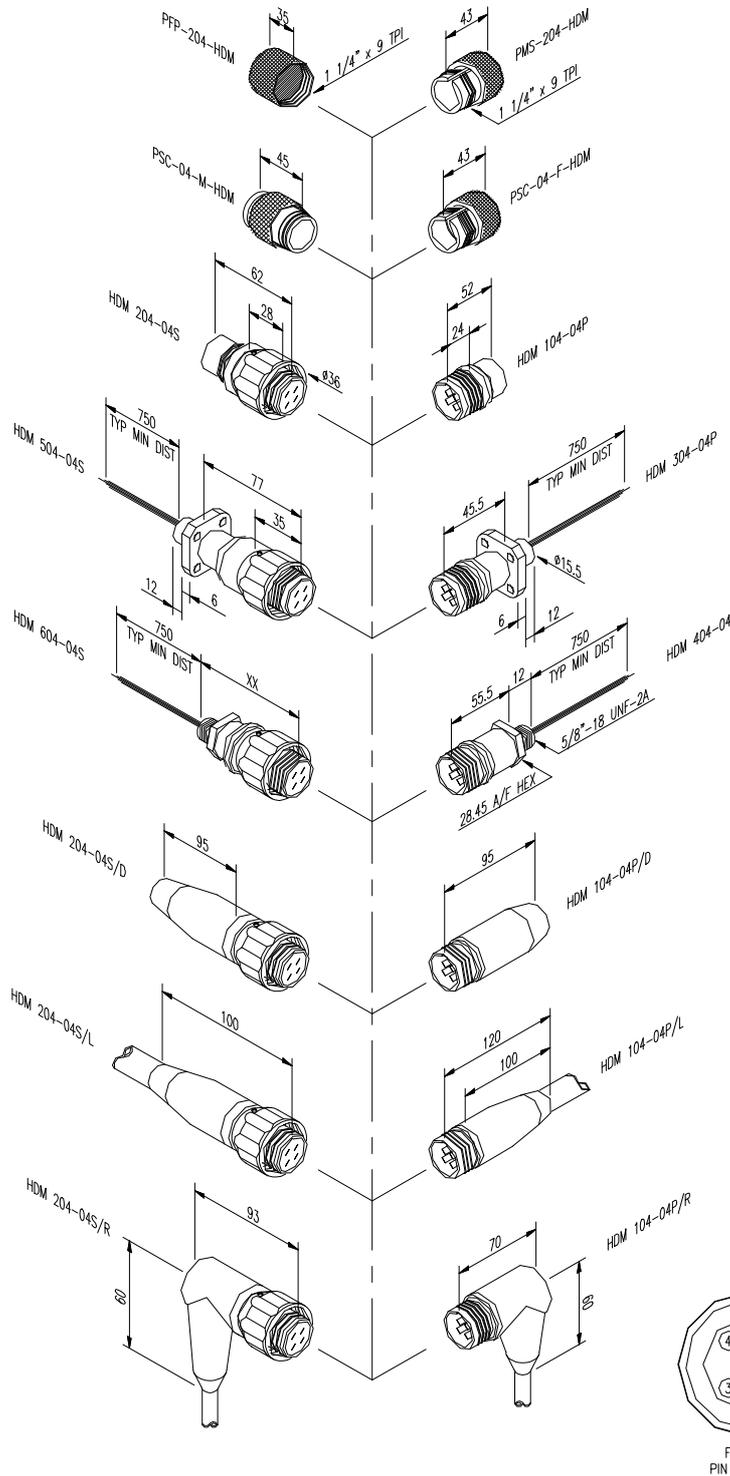
**Mechanical:**

Lengths = mm  
 Threads = Inches  
**Mounting Detail:**  
 See Mounting Detail  
 Section of Binder

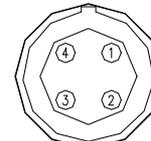
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**HDM (Hydrobond Deck Mate)  
Surface Mateable Connector  
HDM\_04-04**



FACE VIEW  
SOCKET CONNECTOR



FACE VIEW  
PIN CONNECTOR

**Electrical and Environmental:**

Pin Current Rating: 10 Amps  
 Pin Voltage Rating: 1,500 V rms  
 Contact to Contact IR: >1,000 MOhms @ 1,000 V dc  
 Contact to Body IR: >1,000 MOhms @ 1,000 V dc  
 Mated Depth Rating: 3,450 MSW  
 Temperature Rating: -20 ° C to +60 ° C  
 Conductor Tail Size: 16 AWG  
 Solder Bucket Size: 1.6 mm dia

**Standard Material Specification:**

Body: 316 Stainless Steel  
 Fix Ring: Aluminium Silicon Bronze  
 Back Shell: N/A  
 Contact Pins: CZ121/Au  
 Contact Sockets: CZ121/Au  
 Insert Material: Peek  
 Conductor Tails: Spec 44 X 1.0 m.  
 O – Rings: NI70

**Data Sheet:**

Issue: 02  
 Approved by:

**Mechanical:**

Lengths = mm  
 Threads = Inches

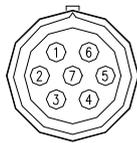
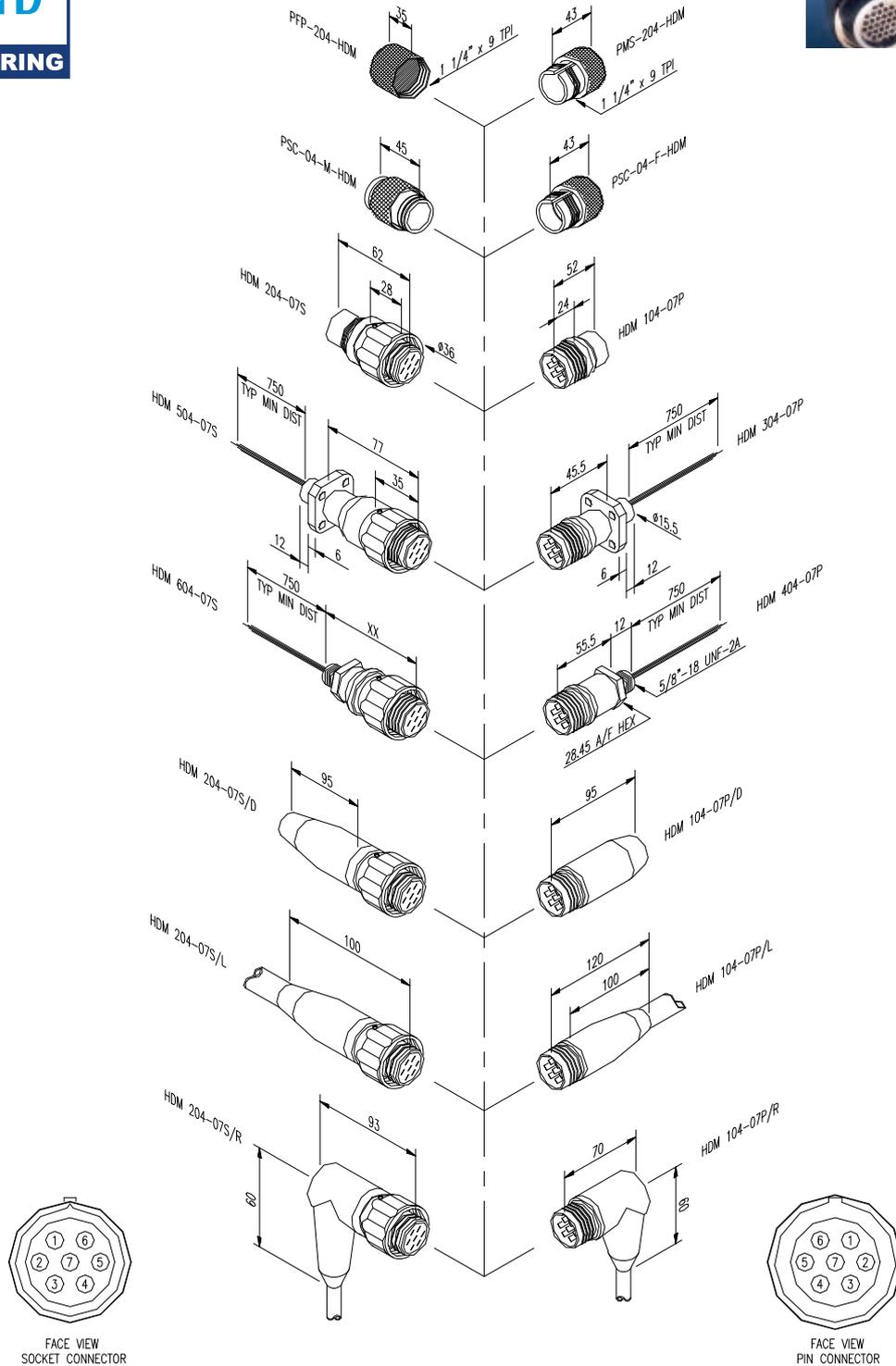
**Mounting Detail:**

See Mounting Detail  
 Section of Binder

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# HDM (Hydrobond Deck Mate) Surface Mateable Connector HDM\_04-07



FACE VIEW  
SOCKET CONNECTOR



FACE VIEW  
PIN CONNECTOR

### Electrical and Environmental:

Pin Current Rating: 8 Amps  
 Pin Voltage Rating: 1,000 V rms  
 Contact to Contact IR: >1,000 MOhms @ 1,000 V dc  
 Contact to Body IR: >1,000 MOhms @ 1,000 V dc  
 Mated Depth Rating: 3,450 MSW  
 Temperature Rating: -20 °C to +60 °C  
 Conductor Tail Size: 16 AWG  
 Solder Bucket Size: 1.4 mm dia

### Standard Material Specification:

Body: 316 Stainless Steel  
 Fix Ring: Aluminium Silicon Bronze  
 Back Shell: N/A  
 Contact Pins: CZI21/Au  
 Contact Sockets: CZI21/Au  
 Insert Material: Peek  
 Conductor Tails: Spec 44 X 1.0 m.  
 O – Rings: NI70

### Data Sheet:

Issue: 02  
 Approved by:

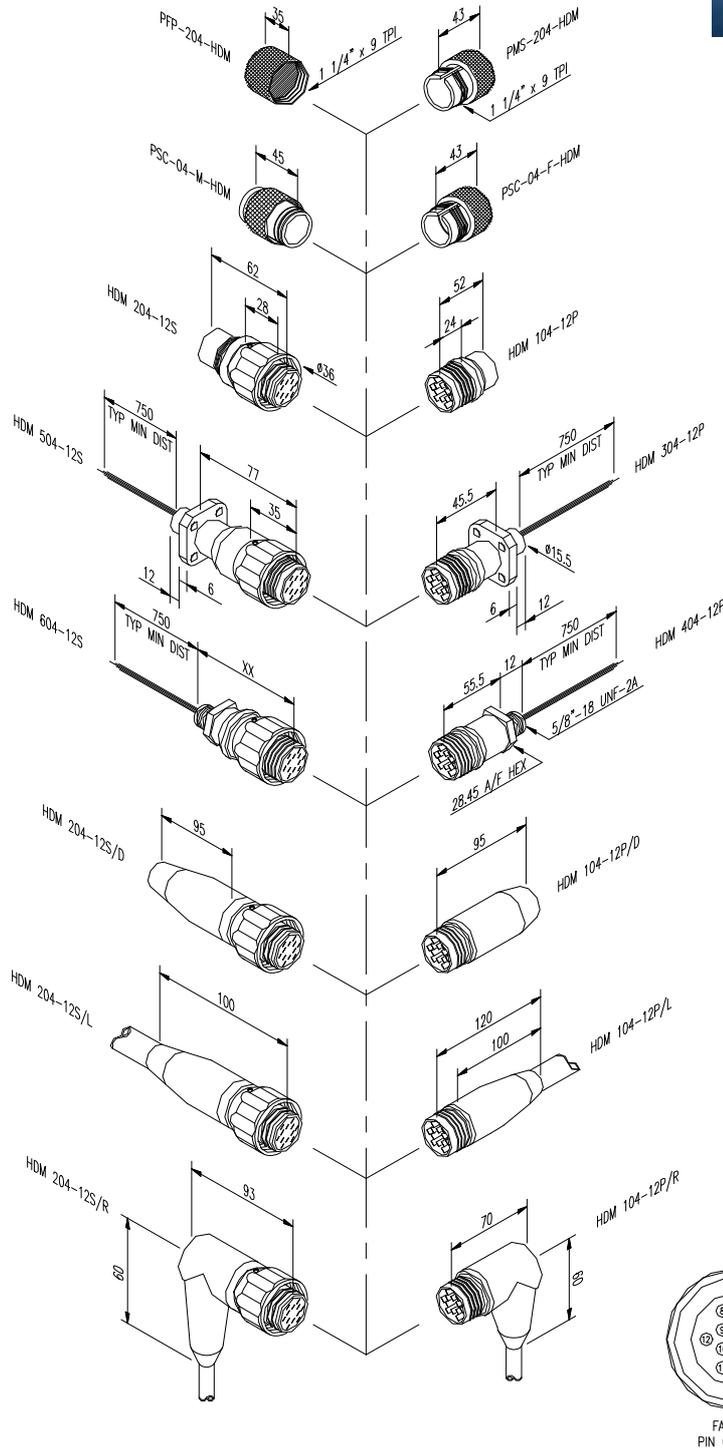
### Mechanical:

Lengths = mm  
 Threads = Inches  
 Mounting Detail:  
 See Mounting Detail  
 Section of Binder

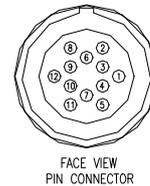
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# HDM (Hydrobond Deck Mate) Surface Mateable Connector HDM\_04-12



FACE VIEW  
SOCKET CONNECTOR



FACE VIEW  
PIN CONNECTOR

**Electrical and Environmental:**

Pin Current Rating: 4 Amps  
 Pin Voltage Rating: 1,000 V rms  
 Contact to Contact IR: >1,000 MOhms @ 1,000 V dc  
 Contact to Body IR: >1,000 MOhms @ 1,000 V dc  
 Mated Depth Rating: 3,450 MSW  
 Temperature Rating: -20 ° C to +60 ° C  
 Conductor Tail Size: 20 AWG  
 Solder Bucket Size: 1.2 mm dia

**Standard Material Specification:**

Body: 316 Stainless Steel  
 Fix Ring: Aluminium Silicon Bronze  
 Back Shell: N/A  
 Contact Pins: CZ121/Au  
 Contact Sockets: CZ121/Au  
 Insert Material: Peek  
 Conductor Tails: Spec 44 X 1.0 m.  
 O – Rings: NI70

**Data Sheet:**

Issue: 02  
 Approved by:

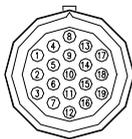
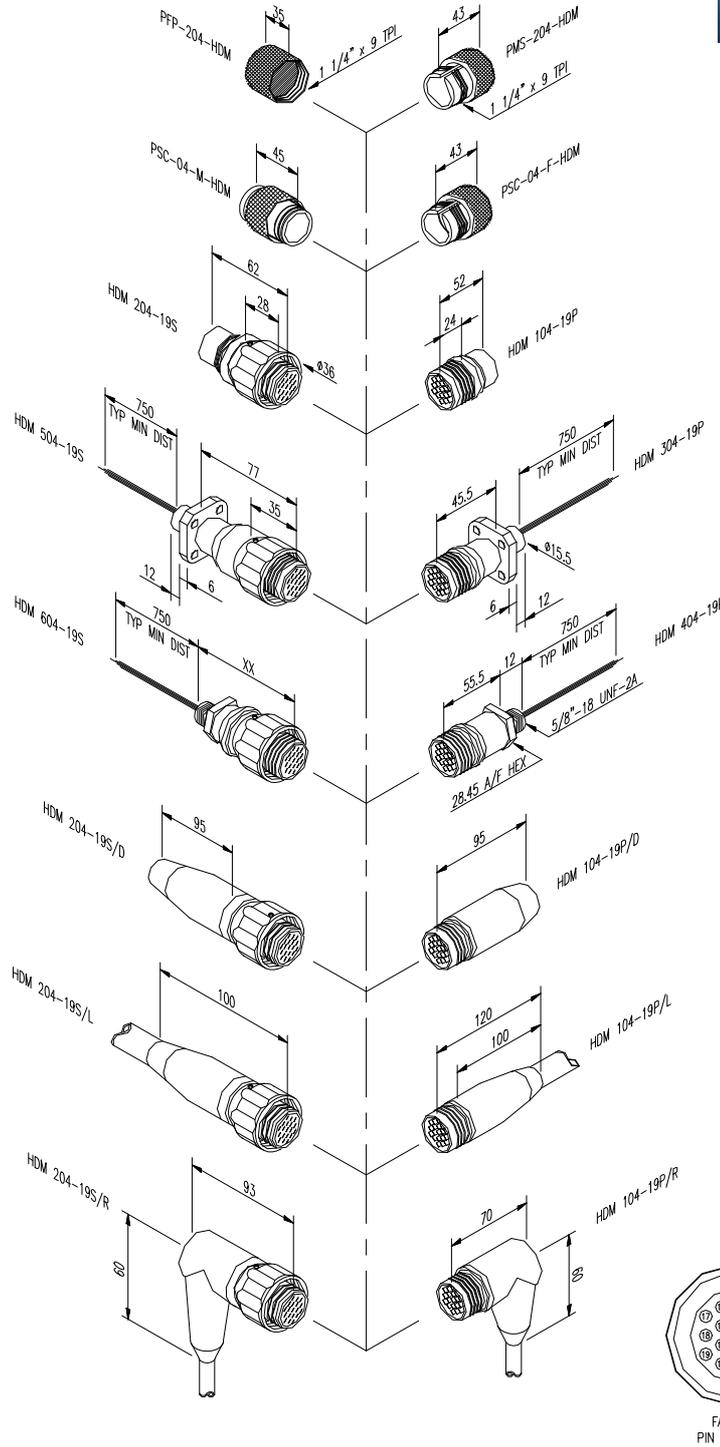
**Mechanical:**

Lengths = mm  
 Threads = Inches  
**Mounting Detail:**  
 See Mounting Detail  
 Section of Binder

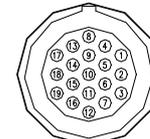
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**HDM (Hydrobond Deck Mate)  
Surface Mateable Connector  
HDM\_04-19**



FACE VIEW  
SOCKET CONNECTOR



FACE VIEW  
PIN CONNECTOR

**Electrical and Environmental:**

Pin Current Rating: 4 Amps  
 Pin Voltage Rating: 1,000 V rms  
 Contact to Contact IR: >1,000 MOhms @ 1,000 V dc  
 Contact to Body IR: >1,000 MOhms @ 1,000 V dc  
 Mated Depth Rating: 3,450 MSW  
 Temperature Rating: -20 ° C to +60 ° C  
 Conductor Tail Size: 18 AWG  
 Solder Bucket Size: 1.2 mm dia

**Standard Material Specification:**

Body: 316 Stainless Steel  
 Fix Ring: Aluminium Silicon Bronze  
 Back Shell: N/A  
 Contact Pins: CZI21/Au  
 Contact Sockets: CZI21/Au  
 Insert Material: Peek  
 Conductor Tails: Spec 44 X 1.0 m.  
 O – Rings: NI70

**Data Sheet:**

Issue: 02  
 Approved by:

**Mechanical:**

Lengths = mm  
 Threads = Inches

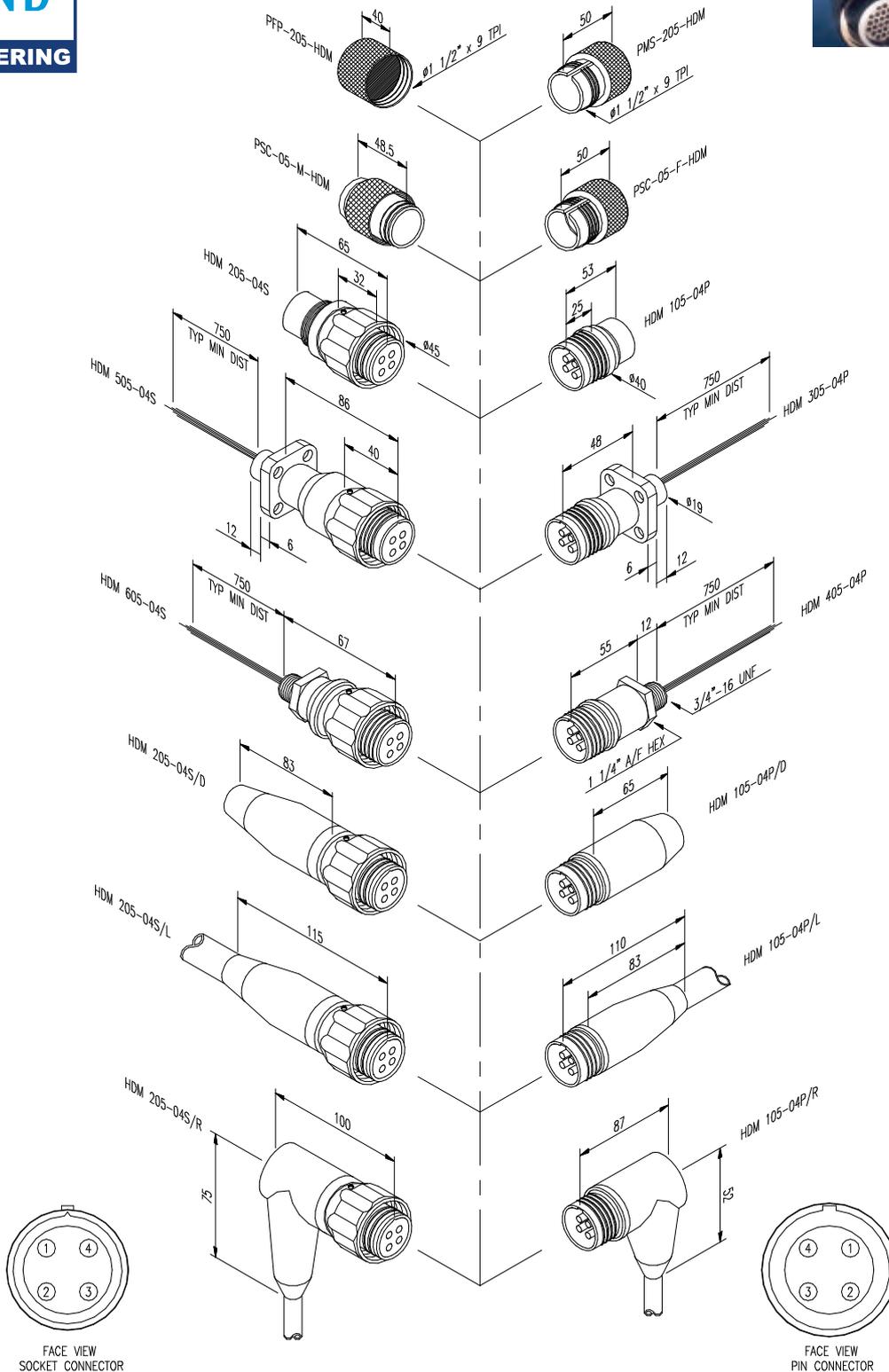
**Mounting Detail:**

See Mounting Detail  
 Section of Binder

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# HDM (Hydrobond Deck Mate) Surface Mateable Connector HDM\_05-04



**Electrical and Environmental:**

Pin Current Rating: 27 Amps  
 Pin Voltage Rating: 1,500 V rms  
 Contact to Contact IR: >1,000 MOhms @ 1,000 V dc  
 Contact to Body IR: >1,000 MOhms @ 1,000 V dc  
 Mated Depth Rating: 3,450 MSW  
 Temperature Rating: -20 ° C to +60 ° C  
 Conductor Tail Size: 10 AWG  
 Solder Bucket Size: 3.2 mm dia

**Standard Material Specification:**

Body: 316 Stainless Steel  
 Fix Ring: Aluminium Silicon Bronze  
 Back Shell: N/A  
 Contact Pins: CZ121/Au  
 Contact Sockets: CZ121/Au  
 Insert Material: Peek  
 Conductor Tails: Spec 44 X 1.0 m.  
 O – Rings: NI70

**Data Sheet:**

Issue: 01  
 Approved by:

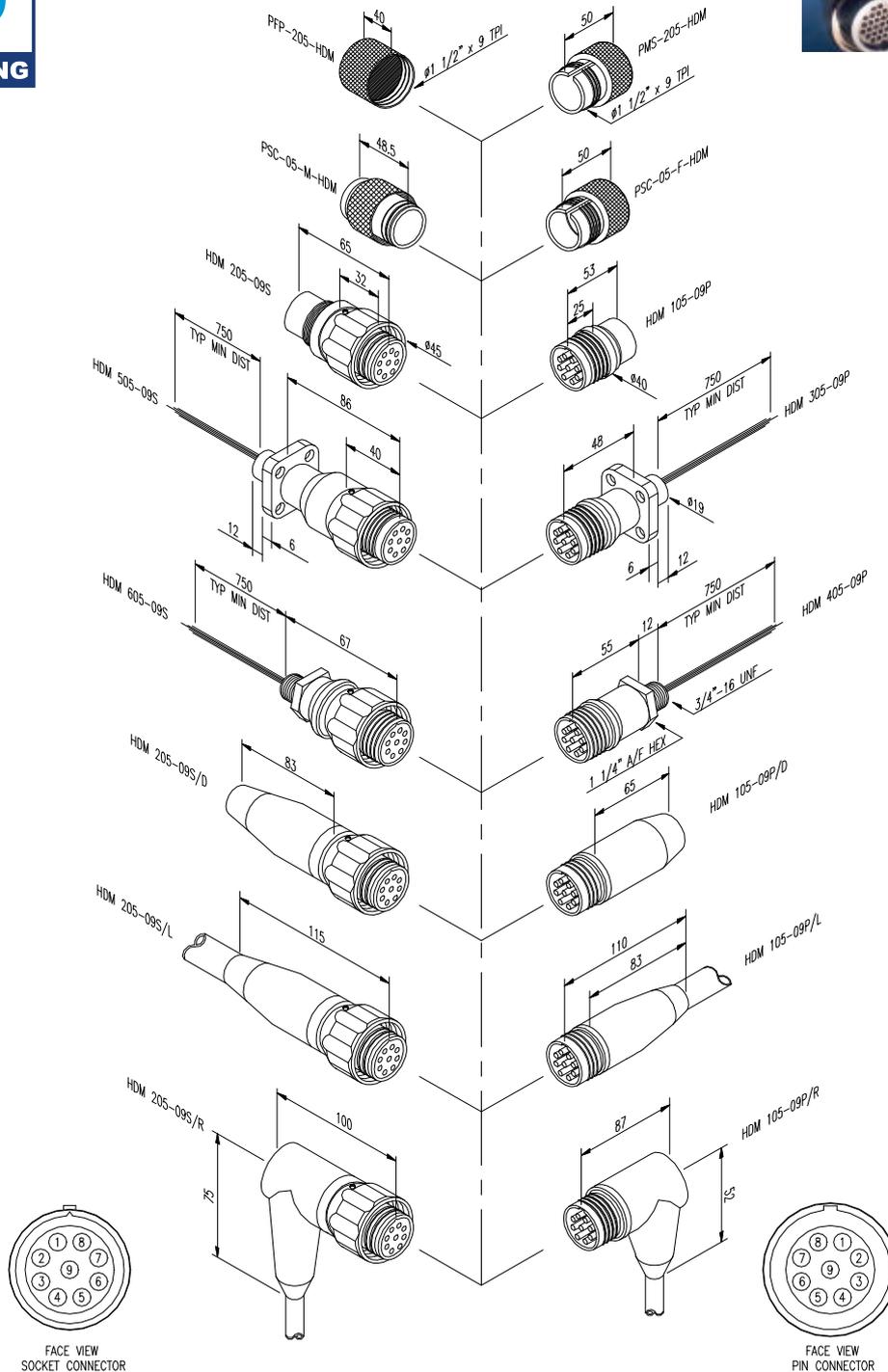
**Mechanical:**

Lengths = mm  
 Threads = Inches  
 Mounting Detail:  
 See Mounting Detail  
 Section of Binder

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## HDM (Hydrobond Deck Mate) Surface Mateable Connector HDM\_05-09



### Electrical and Environmental:

Pin Current Rating: 8 Amps  
 Pin Voltage Rating: 1,500 V rms  
 Contact to Contact IR: >1,000 MOhms @ 1,000 V dc  
 Contact to Body IR: >1,000 MOhms @ 1,000 V dc  
 Mated Depth Rating: 3,450 MSW  
 Temperature Rating: -20 °C to +60 °C  
 Conductor Tail Size: 16 AWG  
 Solder Bucket Size: 1.6 mm dia

### Standard Material Specification:

Body: 316 Stainless Steel  
 Fix Ring: Aluminium Silicon Bronze  
 Back Shell: N/A  
 Contact Pins: CZ121/Au  
 Contact Sockets: CZ121/Au  
 Insert Material: Peek  
 Conductor Tails: Spec 44 X 1.0 m.  
 O - Rings: NI70

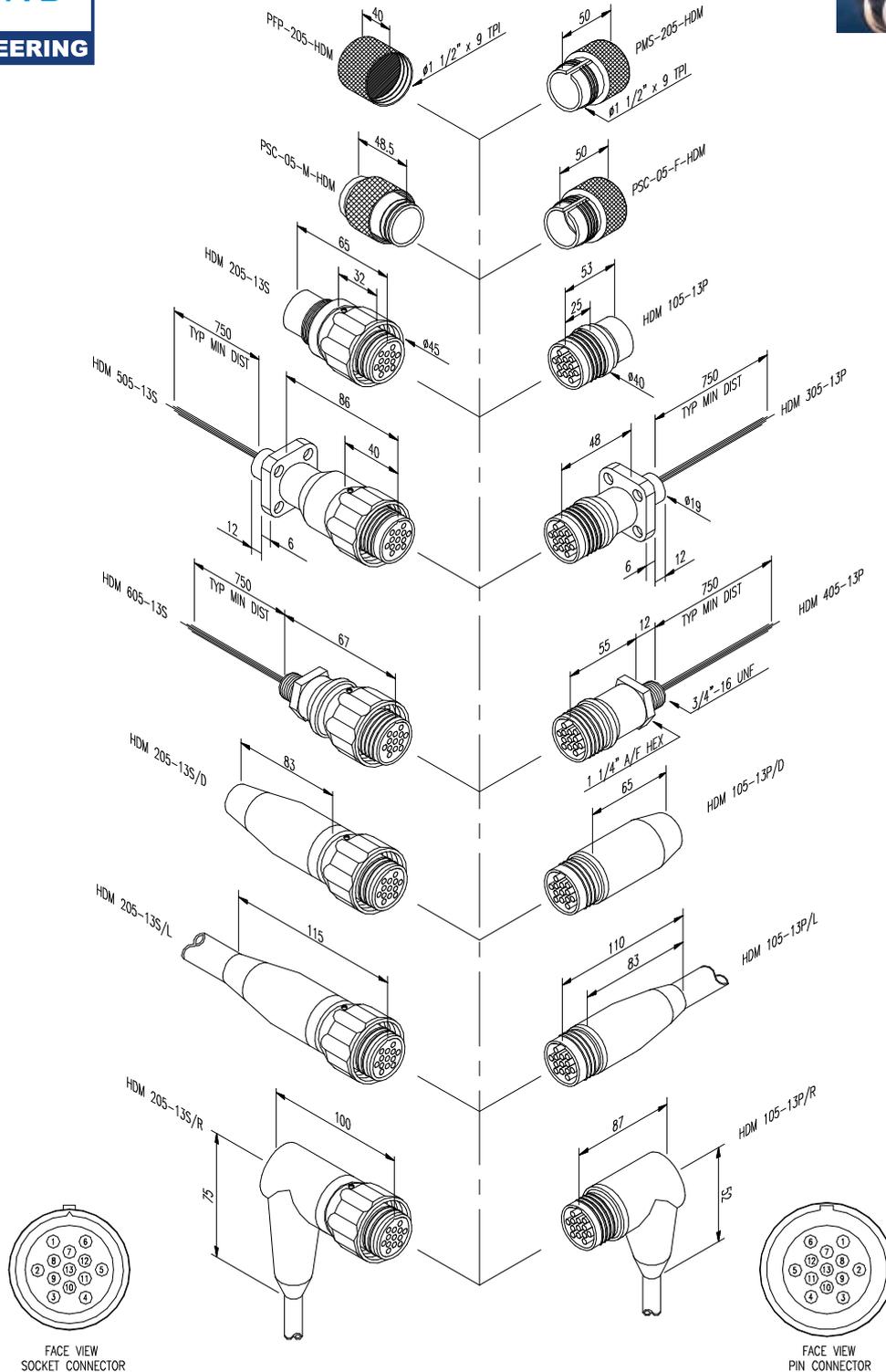
### Data Sheet:

Issue: 02  
 Approved by:

### Mechanical:

Lengths = mm  
 Threads = Inches  
**Mounting Detail:**  
 See Mounting Detail  
 Section of Binder

**HDM (Hydrobond Deck Mate)  
Surface Mateable Connector  
HDM\_05-13**



**Electrical and Environmental:**

Pin Current Rating: 6 Amps  
 Pin Voltage Rating: 1,000 V rms  
 Contact to Contact IR: >1,000 MOhms @ 1,000 V dc  
 Contact to Body IR: >1,000 MOhms @ 1,000 V dc  
 Mated Depth Rating: 3,450 MSW  
 Temperature Rating: -20 °C to +60 °C  
 Conductor Tail Size: 18 AWG  
 Solder Bucket Size: 1.6 mm dia

**Standard Material Specification:**

Body: 316 Stainless Steel  
 Fix Ring: Aluminium Silicon Bronze  
 Back Shell: N/A  
 Contact Pins: CZ121/Au  
 Contact Sockets: CZ121/Au  
 Insert Material: Peek  
 Conductor Tails: Spec 44 X 1.0 m.  
 O – Rings: NI70

**Data Sheet:**

Issue: 01  
 Approved by:

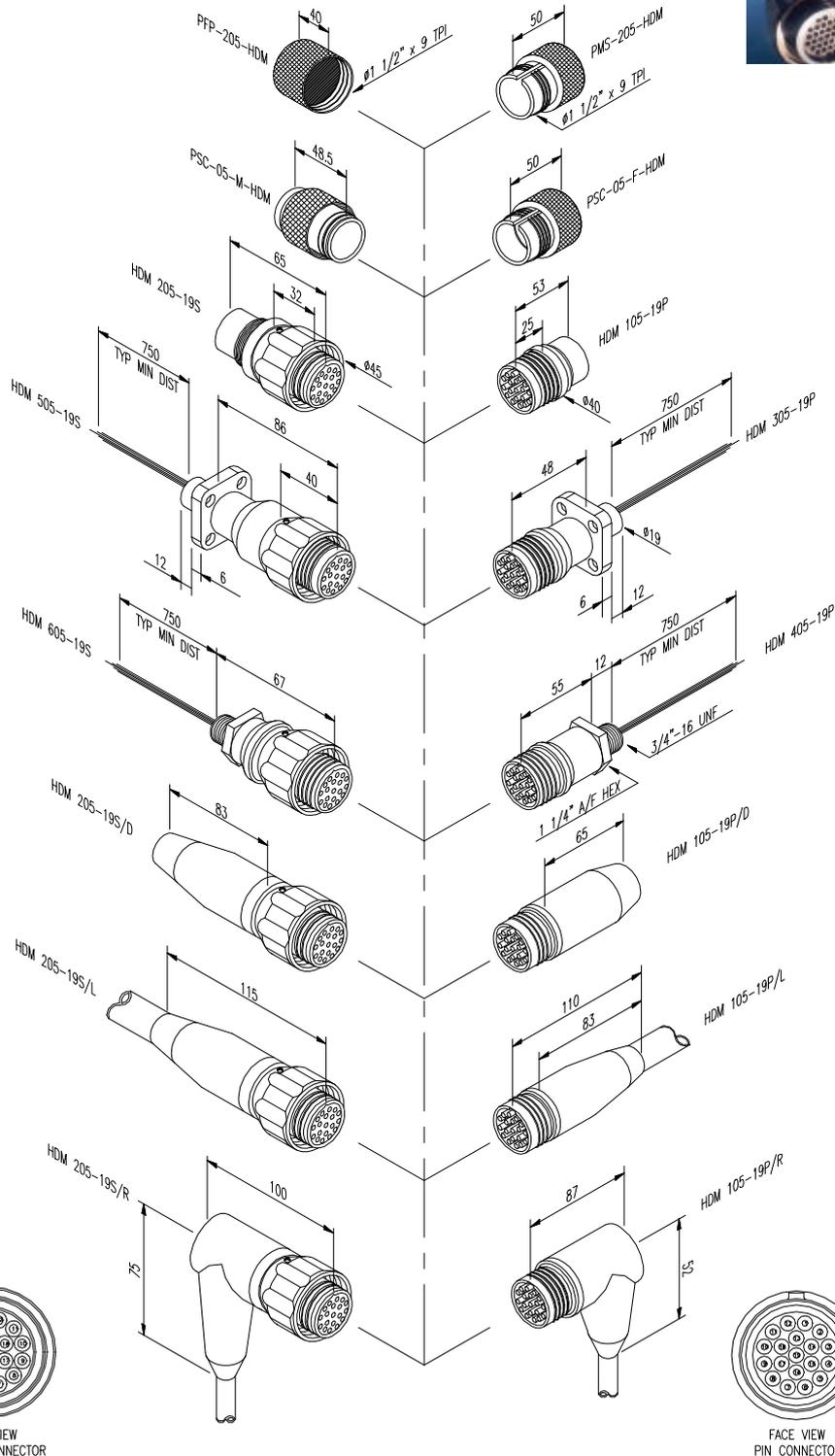
**Mechanical:**

Lengths = mm  
 Threads = Inches  
**Mounting Detail:**  
 See Mounting Detail  
 Section of Binder

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**HDM (Hydrobond Deck Mate)  
Surface Mateable Connector  
HDM\_05-19**



**Electrical and Environmental:**

- Pin Current Rating: 3 Amps
- Pin Voltage Rating: 1,000 V rms
- Contact to Contact IR: >1,000 MOhms @ 1,000 V dc
- Contact to Body IR: >1,000 MOhms @ 1,000 V dc
- Mated Depth Rating: 3,450 MSW
- Temperature Rating: -20 °C to +60 °C
- Conductor Tail Size: 18 AWG
- Solder Bucket Size: 1.2 mm dia

**Standard Material Specification:**

- Body: 316 Stainless Steel
- Fixed Ring: Aluminium Silicon Bronze
- Back Shell: N/A
- Contact Pins: CZI21/Au
- Contact Sockets: CZI21/Au
- Insert Material: Peek
- Conductor Tails: Spec 44 X 1.0 m.
- O – Rings: NI70

**Data Sheet:**

- Issue: 01
- Approved by:

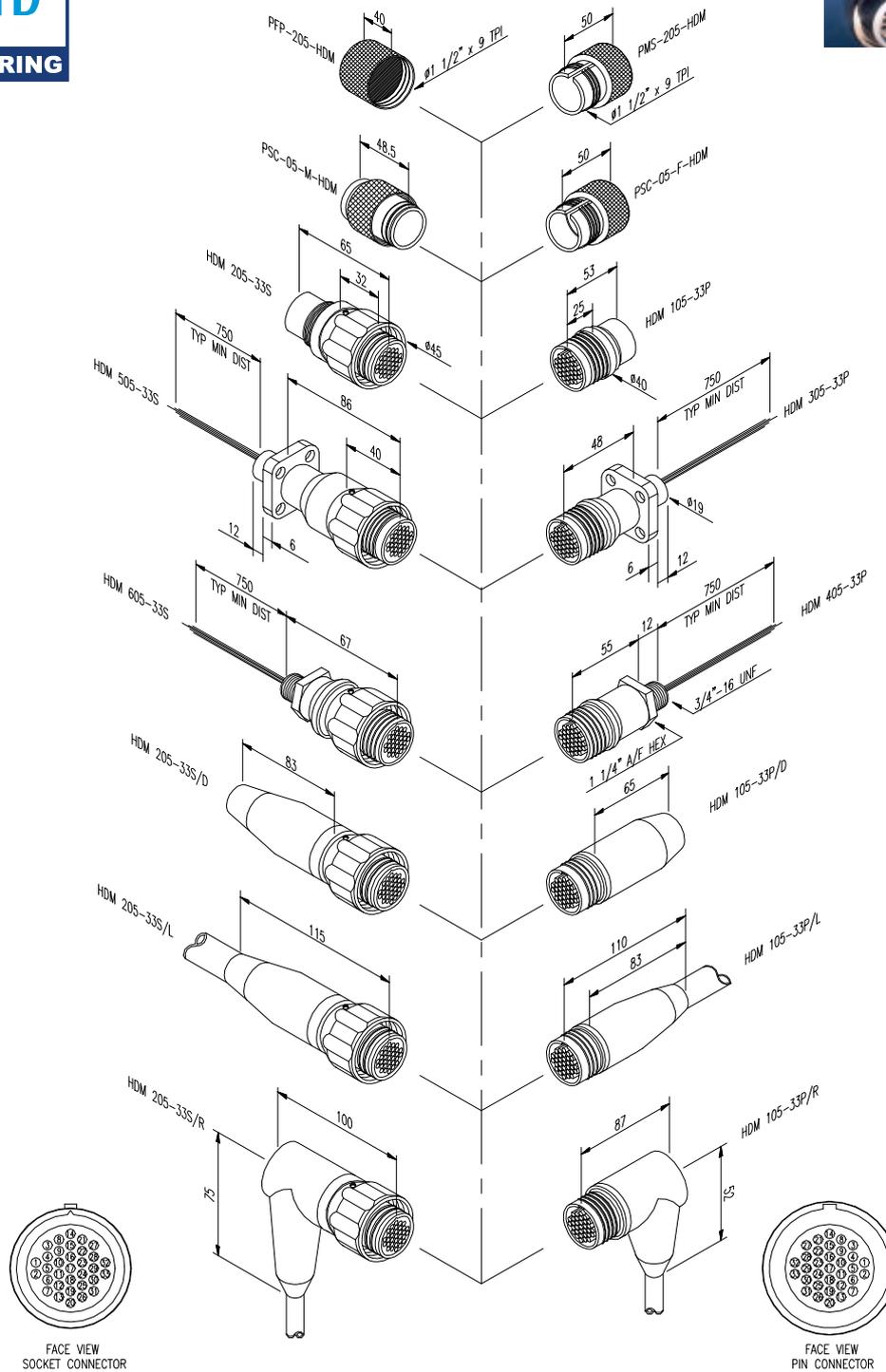
**Mechanical:**

- Lengths = mm
- Threads = Inches
- Mounting Detail:  
See Mounting Detail  
Section of Binder

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## HDM (Hydrobond Deck Mate) Surface Mateable Connector HDM\_05-33



### Electrical and Environmental:

Pin Current Rating: 2 Amps  
 Pin Voltage Rating: 1,000 V rms  
 Contact to Contact IR: >1,000 MOhms @ 1,000 V dc  
 Contact to Body IR: >1,000 MOhms @ 1,000 V dc  
 Mated Depth Rating: 3,450 MSW  
 Temperature Rating: -20 °C to +60 °C  
 Conductor Tail Size: 18 AWG  
 Solder Bucket Size: 1.2 mm dia

### Standard Material Specification:

Body: 316 Stainless Steel  
 Fix Ring: Aluminium Silicon Bronze  
 Back Shell: N/A  
 Contact Pins: CZI21/Au  
 Contact Sockets: CZI21/Au  
 Insert Material: Peek  
 Conductor Tails: Spec 44 X 1.0 m.  
 O - Rings: NI70

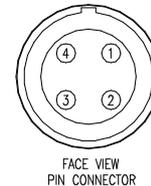
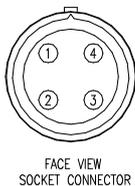
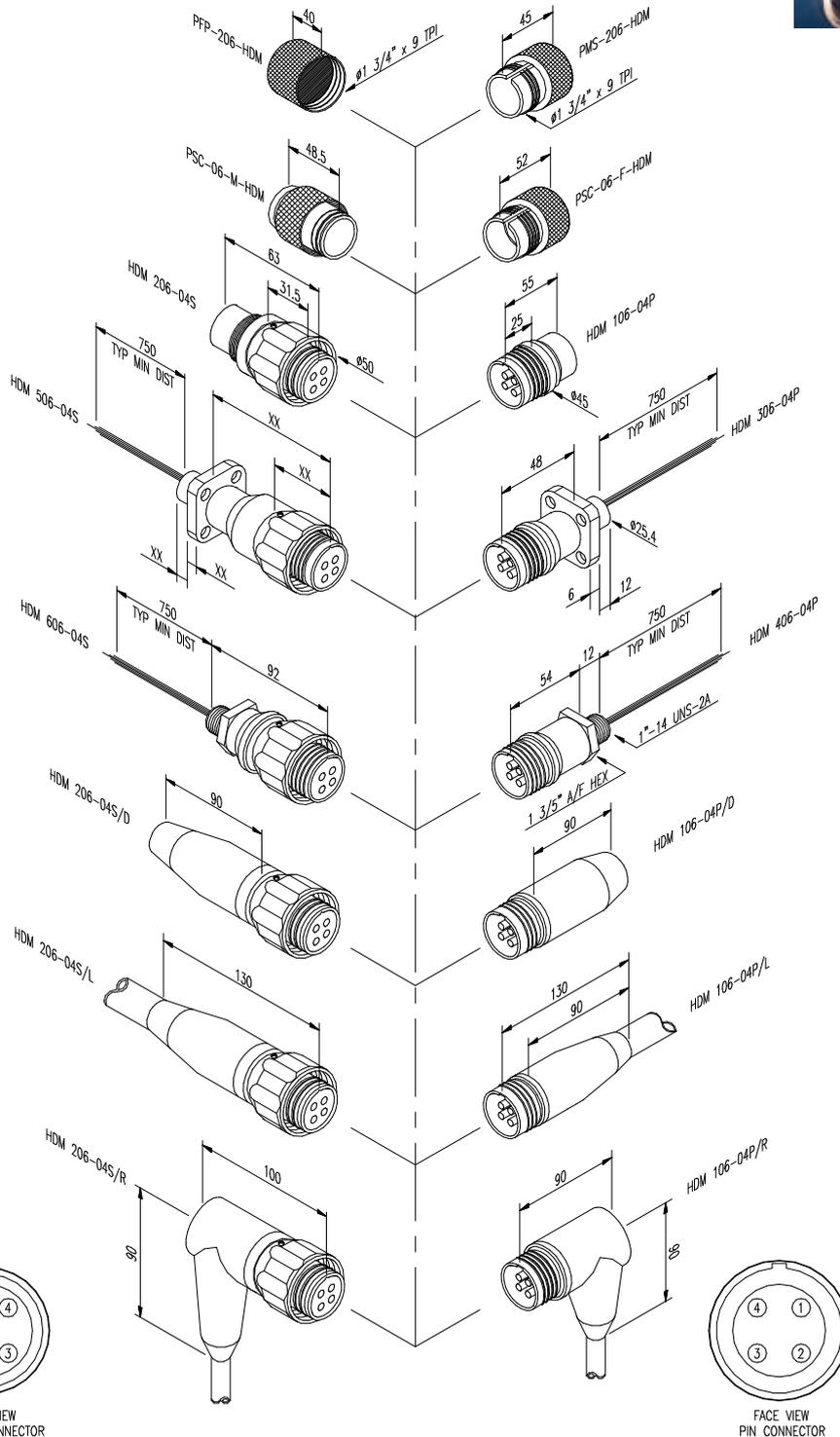
### Data Sheet:

Issue: 02  
 Approved by:

### Mechanical:

Lengths = mm  
 Threads = Inches  
 Mounting Detail:  
 See Mounting Detail  
 Section of Binder

**HDM (Hydrobond Deck Mate)  
Surface Mateable Connector  
HDM\_06-04**



**Electrical and Environmental:**

Pin Current Rating: 20 Amps  
 Pin Voltage Rating: 3,000 V rms  
 Contact to Contact IR: >1,000 MOhms @ 1,000 V dc  
 Contact to Body IR: >1,000 MOhms @ 1,000 V dc  
 Mated Depth Rating: 3,450 MSW  
 Temperature Rating: -20 °C to +60 °C  
 Conductor Tail Size: 12 AWG  
 Solder Bucket Size: 2.5 mm dia

**Standard Material Specification:**

Body: 316 Stainless Steel  
 Fix Ring: Aluminium Silicon Bronze  
 Back Shell: N/A  
 Contact Pins: CZ121/Au  
 Contact Sockets: CZ121/Au  
 Insert Material: Peek  
 Conductor Tails: Spec 44 X 1.0 m.  
 O – Rings: NI70

**Data Sheet:**

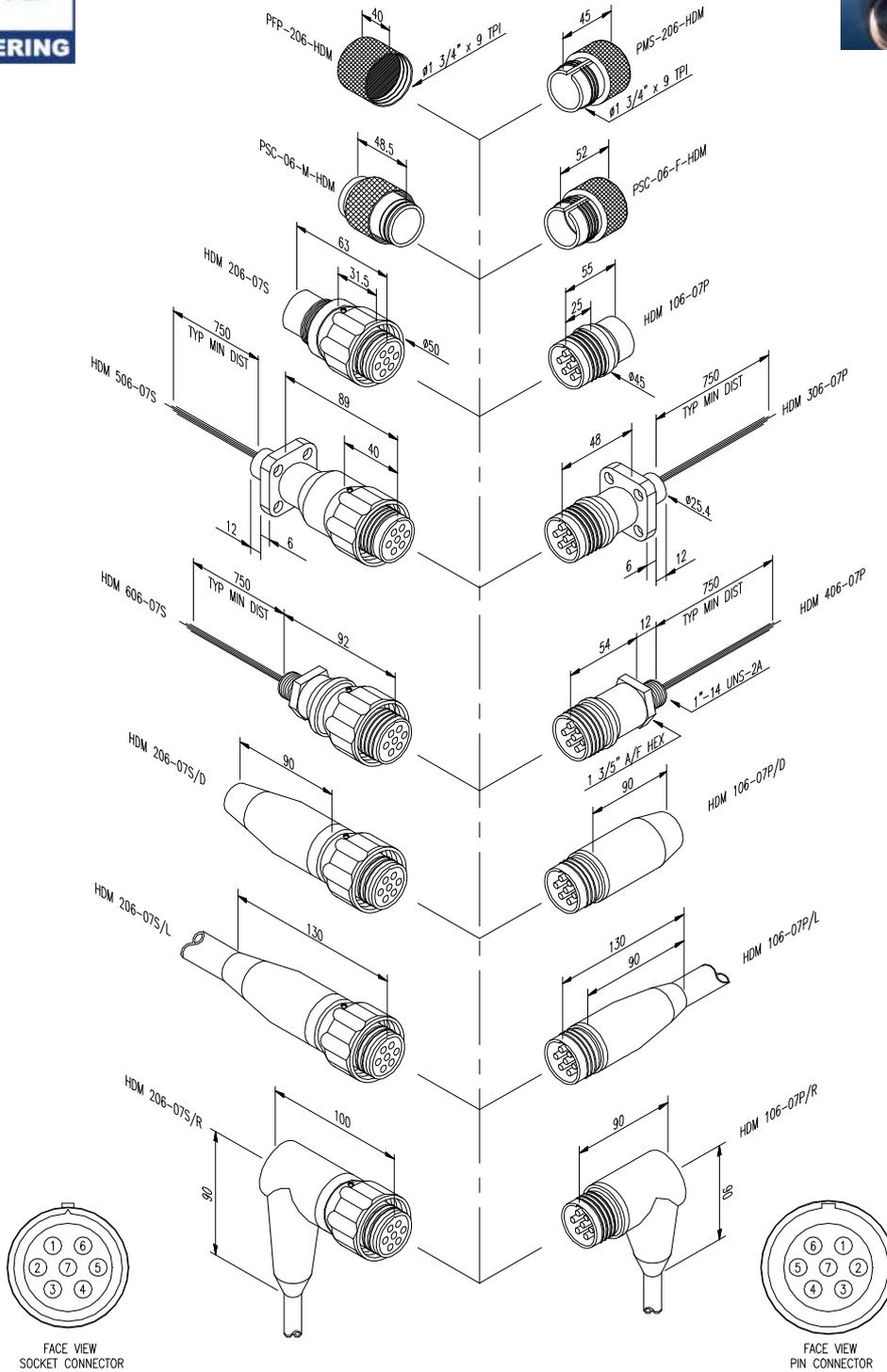
Issue: 01  
 Approved by:

**Mechanical:**

Lengths = mm  
 Threads = Inches  
 Mounting Detail:  
 See Mounting Detail  
 Section of Binder



# HDM (Hydrobond Deck Mate) Surface Mateable Connector HDM\_06-07



### Electrical and Environmental:

Pin Current Rating: 22 Amps  
 Pin Voltage Rating: 1,500 V rms  
 Contact to Contact IR: >1,000 MOhms @ 1,000 V dc  
 Contact to Body IR: >1,000 MOhms @ 1,000 V dc  
 Mated Depth Rating: 3,450 MSW  
 Temperature Rating: -20 ° C to +60 ° C  
 Conductor Tail Size: 12 AWG  
 Solder Bucket Size: 2.5 mm dia

### Standard Material Specification:

Body: 316 Stainless Steel  
 Fix Ring: Aluminium Silicon Bronze  
 Back Shell: N/A  
 Contact Pins: CZ121/Au  
 Contact Sockets: CZ121/Au  
 Insert Material: Peek  
 Conductor Tails: Spec 44 X 1.0 m.  
 O – Rings: NI70

### Data Sheet:

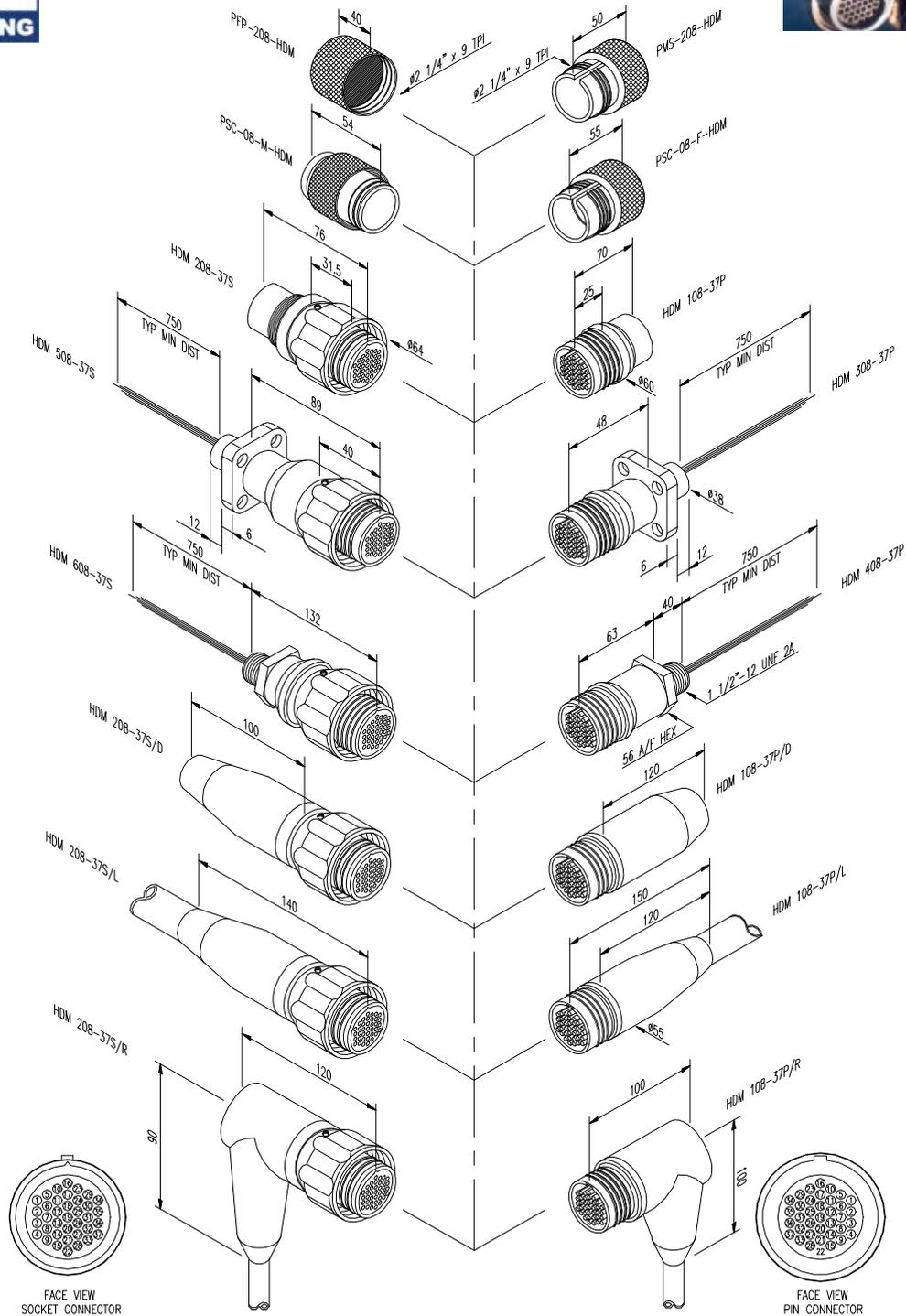
Issue: 01  
 Approved by:

### Mechanical:

Lengths = mm  
 Threads = Inches  
 Mounting Detail:  
 See Mounting Detail  
 Section of Binder



# HDM (Hydrobond Deck Mate) Surface Mateable Connector HDM\_06-37



### Electrical and Environmental:

Pin Current Rating: 3 Amps  
 Pin Voltage Rating: 1,000 V rms  
 Contact to Contact IR: >1,000 MOhms @ 1,000 V dc  
 Contact to Body IR: >1,000 MOhms @ 1,000 V dc  
 Mated Depth Rating: 3,450 MSW  
 Temperature Rating: -20 °C to +60 °C  
 Conductor Tail Size: 18 AWG  
 Solder Bucket Size: 1.2 mm dia

### Standard Material Specification:

Body: 316 Stainless Steel  
 Fix Ring: Aluminium Silicon Bronze  
 Back Shell: N/A  
 Contact Pins: CZI21/Au  
 Contact Sockets: CZI21/Au  
 Insert Material: Peek  
 Conductor Tails: Spec 44 X 1.0 m.  
 O - Rings: NI70

### Data Sheet:

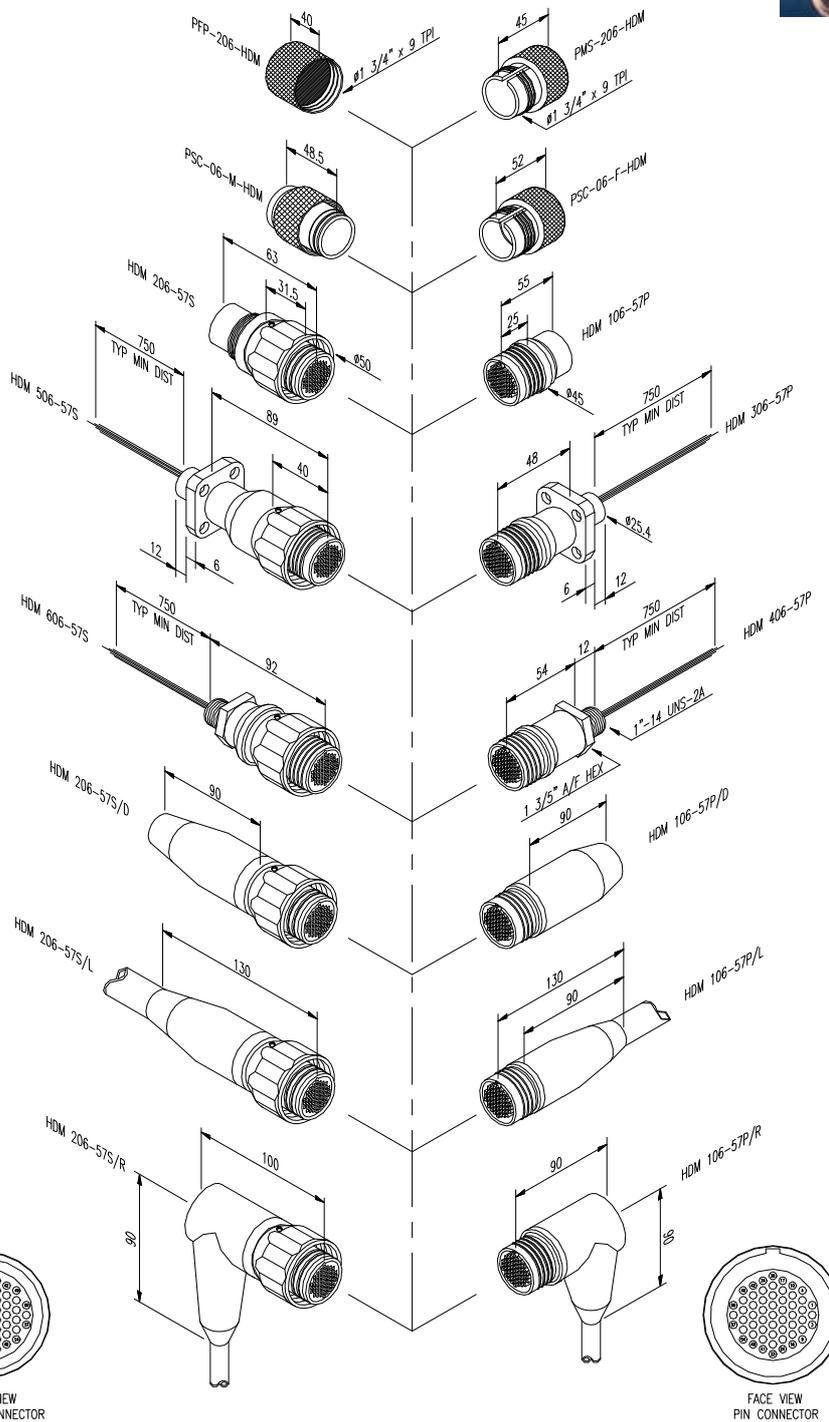
Issue: 02  
 Approved by:

### Mechanical:

Lengths = mm  
 Threads = Inches  
 Mounting Detail:  
 See Mounting Detail  
 Section of Binder



# HDM (Hydrobond Deck Mate) Surface Mateable Connector HDM\_06-57



### Electrical and Environmental:

Pin Current Rating: 2 Amps  
 Pin Voltage Rating: 1,000 V rms  
 Contact to Contact IR: >1,000 MOhms @ 1,000 V dc  
 Contact to Body IR: >1,000 MOhms @ 1,000 V dc  
 Mated Depth Rating: 3,450 MSW  
 Temperature Rating: -20 °C to +60 °C  
 Conductor Tail Size: 18 AWG  
 Solder Bucket Size: 1.2 mm dia

### Standard Material Specification:

Body: 316 Stainless Steel  
 Fix Ring: Aluminium Silicon Bronze  
 Back Shell: N/A  
 Contact Pins: CZI21/Au  
 Contact Sockets: CZI21/Au  
 Insert Material: Peek  
 Conductor Tails: Spec 44 X 1.0 m.  
 O - Rings: NI70

### Data Sheet:

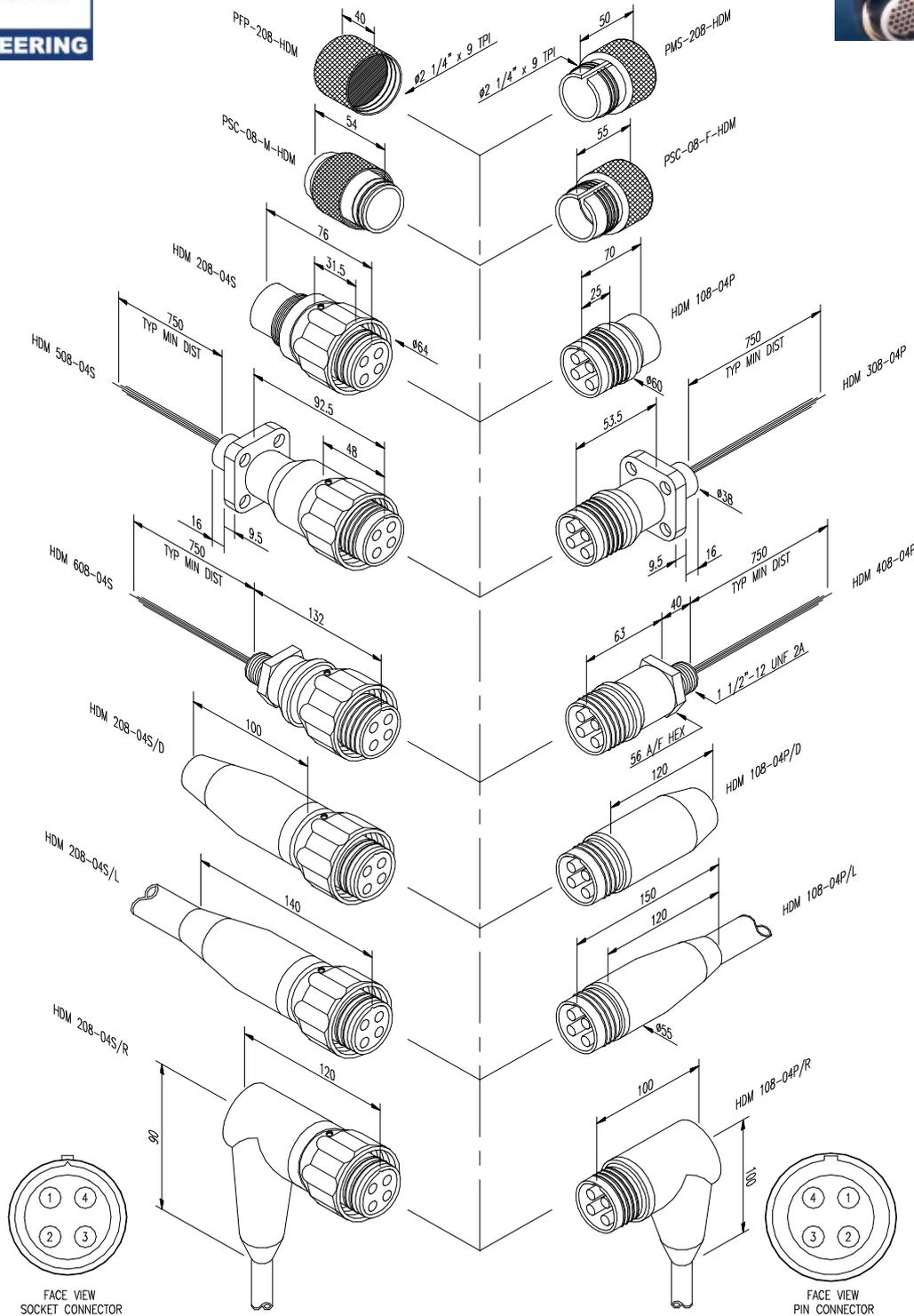
Issue: 02  
 Approved by:

### Mechanical:

Lengths = mm  
 Threads = Inches  
 Mounting Detail:  
 See Mounting Detail  
 Section of Binder



# HDM (Hydrobond Deck Mate) Surface Mateable Connector HDM\_08-04



### Electrical and Environmental:

Pin Current Rating: 60 Amps  
 Pin Voltage Rating: 1,500 V rms  
 Contact to Contact IR: >1,000 MOhms @ 1,000 V dc  
 Contact to Body IR: >1,000 MOhms @ 1,000 V dc  
 Mated Depth Rating: 3,450 MSW  
 Temperature Rating: -20 ° C to +60 ° C  
 Conductor Tail Size: Details on Application  
 Solder Bucket Size: Details on Application

### Standard Material Specification:

Body: 316 Stainless Steel  
 Fix Ring: Aluminium Silicon Bronze  
 Back Shell: N/A  
 Contact Pins: CZ121/Au  
 Contact Sockets: CZ121/Au  
 Insert Material: Peek  
 Conductor Tails: Polyrad X 1.0 m.  
 O – Rings: NI70

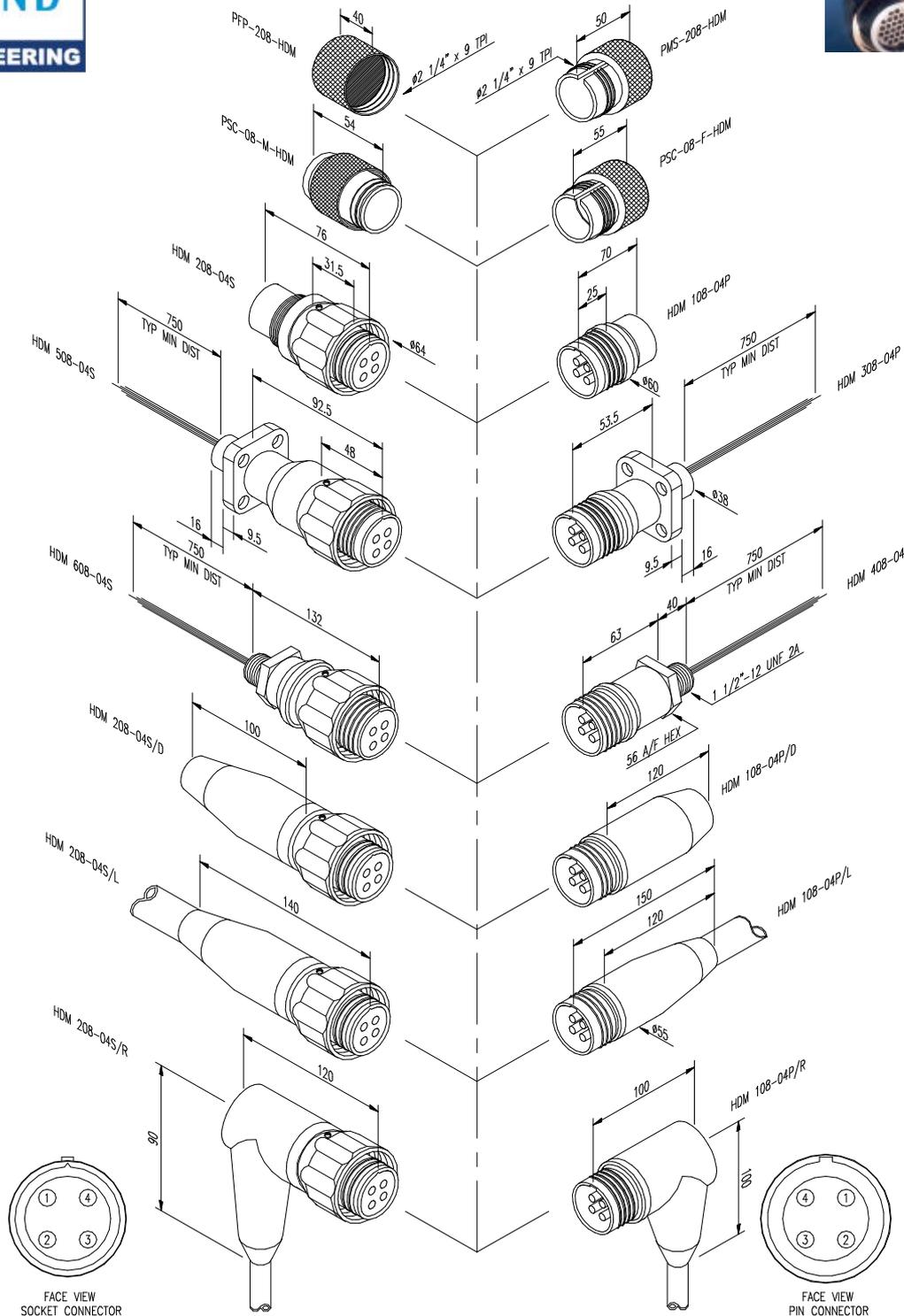
### Data Sheet:

Issue: 02  
 Approved by:

### Mechanical:

Lengths = mm  
 Threads = Inches  
**Mounting Detail:**  
 See Mounting Detail  
 Section of Binder

**HDM (Hydrobond Deck Mate)  
Surface Mateable Connector  
HDM\_08-04-HV**



**Electrical and Environmental:**

Pin Current Rating: 20 Amps  
 Pin Voltage Rating: 3,300 V rms  
 Contact to Contact IR: >1,000 MOhms @ 1,000 V dc  
 Contact to Body IR: >1,000 MOhms @ 1,000 V dc  
 Mated Depth Rating: 3,450 MSW  
 Temperature Rating: -20 ° C to +60 ° C  
 Conductor Tail Size: 13 AWG  
 Solder Bucket Size: 2.5 mm dia

**Standard Material Specification:**

Body: 316 Stainless Steel  
 Fix Ring: Aluminium Silicon Bronze  
 Back Shell: N/A  
 Contact Pins: CZ121/Au  
 Contact Sockets: CZ121/Au  
 Insert Material: Peek  
 Conductor Tails: Reynolds 178-8545  
 X 1.0 m.  
 O – Rings: NI70

**Data Sheet:**

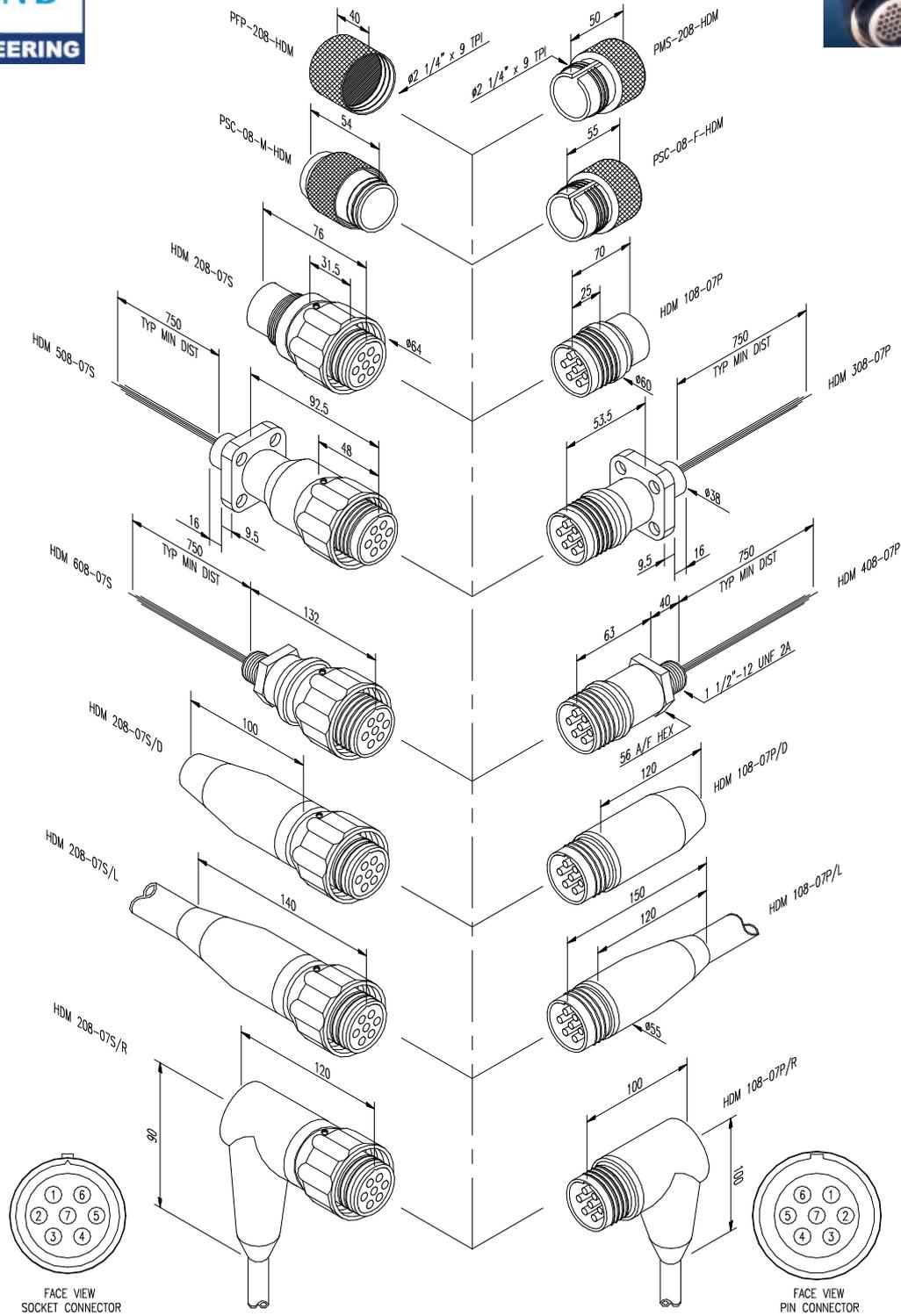
Issue: 01  
 Approved by:

**Mechanical:**

Lengths = mm  
 Threads = Inches  
**Mounting Detail:**  
 See Mounting Detail  
 Section of Binder



# HDM (Hydrobond Deck Mate) Surface Mateable Connector HDM\_08-07



**Electrical and Environmental:**

Pin Current Rating: [Details on Application](#)  
 Pin Voltage Rating: [Details on Application](#)  
 Contact to Contact IR: >1,000 MOhms @ 1,000 V dc  
 Contact to Body IR: >1,000 MOhms @ 1,000 V dc  
 Mated Depth Rating: 3,450 MSW  
 Temperature Rating: -20 °C to +60 °C  
 Conductor Tail Size: 13 AWG  
 Solder Bucket Size: 2.5 mm dia

**Standard Material Specification:**

Body: 316 Stainless Steel  
 Fix Ring: Aluminium Silicon Bronze  
 Back Shell: N/A  
 Contact Pins: CZ121/Au  
 Contact Sockets: CZ121/Au  
 Insert Material: Peek  
 Conductor Tails: Reynolds 178-8545 X 1.0 m.  
 O – Rings: NI70

**Data Sheet:**

Issue: 02  
 Approved by:

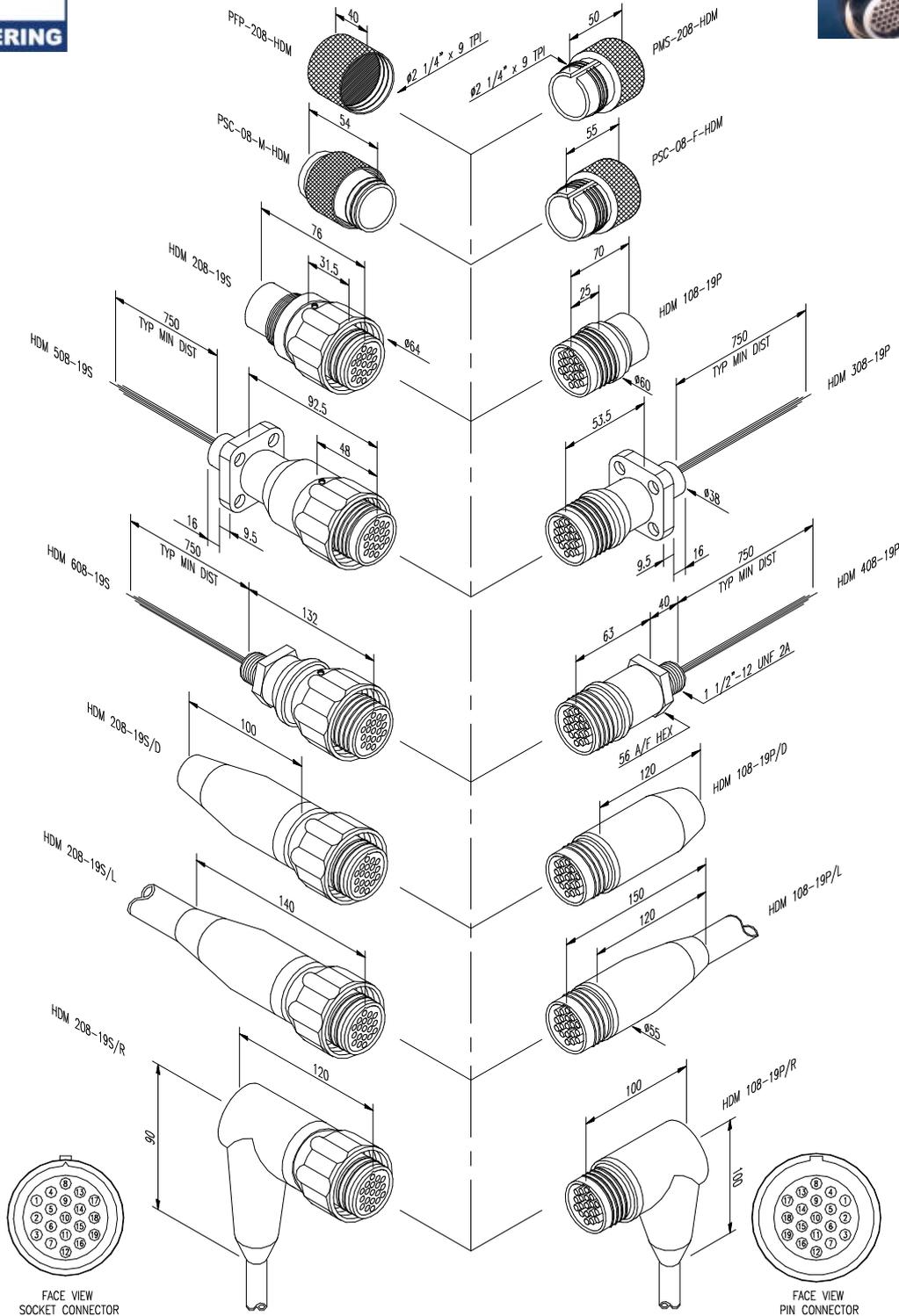
**Mechanical:**

Lengths = mm  
 Threads = Inches  
**Mounting Detail:**  
 See Mounting Detail Section of Binder

**HYDRO  
BOND**

**ENGINEERING**

# HDM (Hydrobond Deck Mate) Surface Mateable Connector HDM\_08-19



**Electrical and Environmental:**

- Pin Current Rating: 5 Amps
- Pin Voltage Rating: 1,500 V rms
- Contact to Contact IR: >1,000 MOhms @ 1,000 V dc
- Contact to Body IR: >1,000 MOhms @ 1,000 V dc
- Mated Depth Rating: 3,450 MSW
- Temperature Rating: -20 ° C to +60 ° C
- Conductor Tail Size: 16 AWG
- Solder Bucket Size: 1.6 mm dia

**Standard Material Specification:**

- Body: 316 Stainless Steel
- Fix Ring: Aluminium Silicon Bronze
- Back Shell: N/A
- Contact Pins: CZ121/Au
- Contact Sockets: CZ121/Au
- Insert Material: Peek
- Conductor Tails: Spec 44 X 1.0 m.
- O – Rings: NI70

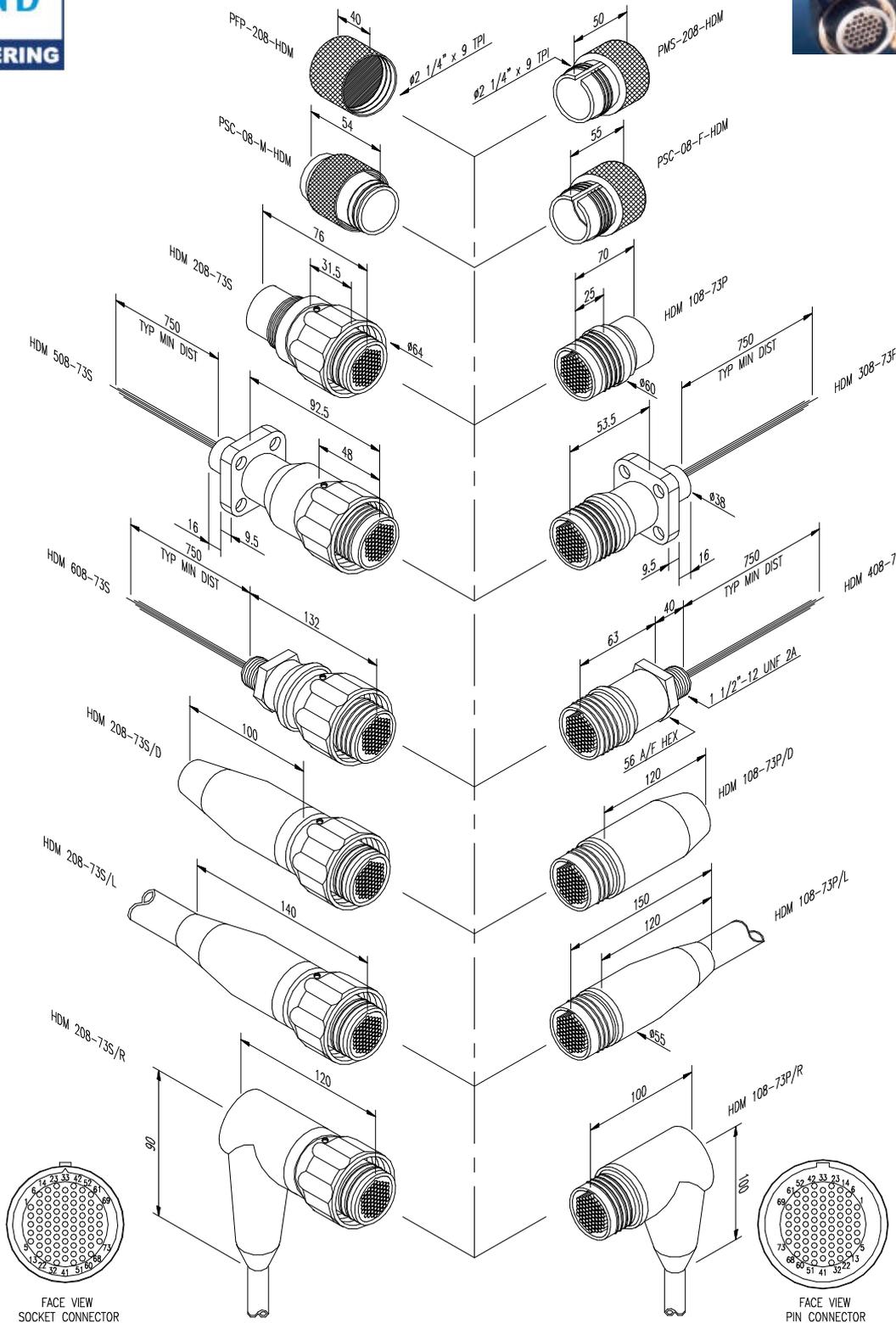
**Data Sheet:**

- Issue: 02
- Approved by:

**Mechanical:**

- Lengths = mm
- Threads = Inches
- Mounting Detail:  
See Mounting Detail  
Section of Binder

**HDM (Hydrobond Deck Mate)  
Surface Mateable Connector  
HDM\_08-73**



FACE VIEW  
SOCKET CONNECTOR

FACE VIEW  
PIN CONNECTOR

**Electrical and Environmental:**

- Pin Current Rating: 2 Amps
- Pin Voltage Rating: 1,000 V rms
- Contact to Contact IR: >1,000 MOhms @ 1,000 V dc
- Contact to Body IR: >1,000 MOhms @ 1,000 V dc
- Mated Depth Rating: 3,450 MSW
- Temperature Rating: -20 ° C to +60 ° C
- Conductor Tail Size: 18 AWG
- Solder Bucket Size: 1.2 mm dia

**Standard Material Specification:**

- Body: 316 Stainless Steel
- Fix Ring: Aluminium Silicon Bronze
- Back Shell: N/A
- Contact Pins: CZ121/Au
- Contact Sockets: CZ121/Au
- Insert Material: Peek
- Conductor Tails: Spec 44 X 1.0 m.
- O – Rings: NI70

**Data Sheet:**

- Issue: 02
- Approved by:

**Mechanical:**

- Lengths = mm
- Threads = Inches
- Mounting Detail:  
See Mounting Detail  
Section of Binder

